

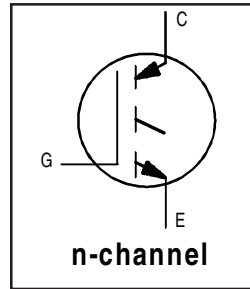
# IRGIH50F

## INSULATED GATE BIPOLAR TRANSISTOR

## Fast Speed IGBT

### Features

- Electrically Isolated and Hermetically Sealed
- Simple Drive Requirements
- Latch-proof
- Fast Speed operation 3 kHz - 8 kHz
- High operating frequency
- Switching-loss rating includes all "tail" losses

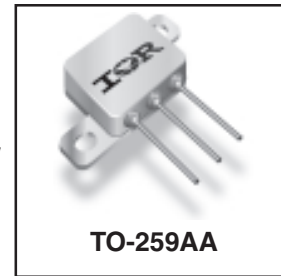


|                             |
|-----------------------------|
| $V_{CES} = 1200V$           |
| $V_{CE(on) \max} = 2.9V$    |
| @ $V_{GE} = 15V, I_C = 25A$ |

### Description

Insulated Gate Bipolar Transistors (IGBTs) from International Rectifier have higher usable current densities than comparable bipolar transistors, while at the same time having simpler gate-drive requirements of the familiar power MOSFET. They provide substantial benefits to a host of high-voltage, high-current applications.

The performance of various IGBTs varies greatly with frequency. Note that IR now provides the designer with a speed benchmark ( $f_{IC/2}$ , or the "half-current frequency"), as well as an indication of the current handling capability of the device.



### Absolute Maximum Ratings

|                           | Parameter  | Max.                                   | Units |
|---------------------------|--|--|-------|
| $V_{CES}$                 | Collector-to-Emitter Breakdown Voltage           | 1200                                   | V     |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current                     | 45                                     | A     |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current                     | 25                                     |       |
| $I_{CM}$                  | Pulsed Collector Current ①                       | 180                                    |       |
| $I_{LM}$                  | Clamped Inductive Load Current ②                 | 90                                     |       |
| $V_{GE}$                  | Gate-to-Emitter Voltage                          | $\pm 20$                               |       |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                        | 200                                    | W     |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                        | 80                                     |       |
| $T_J$                     | Operating Junction and Storage Temperature Range | -55 to + 150                           | °C    |
| $T_{STG}$                 |  |  |       |
|                           | Lead Temperature                                 | 300 (0.063in./1.6mm from case for 10s) |       |
|                           | Weight   | 10.5 (typical)                         | g     |

### Thermal Resistance

|            | Parameter           | Min | Typ  | Max   | Units | Test Conditions |
|------------|---------------------|-----|------|-------|-------|-----------------|
| $R_{thJC}$ | Junction-to-Case    | —   | —    | 0.625 | °C/W  |                 |
| $R_{thCS}$ | Case-to-Sink        | —   | 0.21 | —     |       |                 |
| $R_{thJA}$ | Junction-to-Ambient | —   | —    | 30    |       |                 |

For footnotes refer to the last page  
[www.irf.com](http://www.irf.com)

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

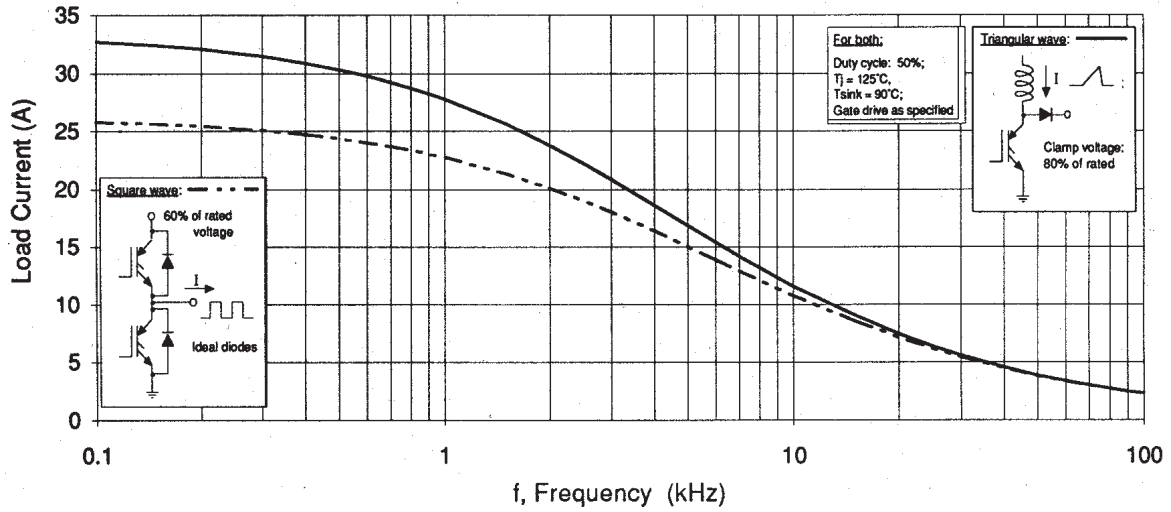
|                                 | Parameter                                | Min. | Typ. | Max.      | Units   | Conditions                                      |
|---------------------------------|--|------|------|-----------|---------|---|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage   | 1200 | —    | —         | V       | $V_{GE} = 0V, I_C = 100 \mu A$                  |
| $V_{(BR)ECS}$                   | Emitter-to-Collector Breakdown Voltage ③ | 22   | —    | —         | V       | $V_{GE} = 0V, I_C = 1.0 A$                      |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage  | —    | 1.1  | —         | V/°C    | $V_{GE} = 0V, I_C = 1.0 mA$                     |
| $V_{CE(ON)}$                    | Collector-to-Emitter Saturation Voltage  | —    | 2.1  | 2.9       | V       | $I_C = 25A$ $V_{GE} = 15V$                      |
|                                 |  | —    | 2.5  | —         |         | $I_C = 45A$ See Fig.2, 5                        |
|                                 |  | —    | 2.4  | —         |         | $I_C = 25A, T_J = 125^\circ C$                  |
| $V_{GE(th)}$                    | Gate Threshold Voltage                   | 3.0  | —    | 5.5       |         | $V_{CE} = V_{GE}, I_C = 250 \mu A$              |
| $\Delta V_{GE(th)}/\Delta T_J$  | Temperature Coeff. of Threshold Voltage  | —    | -14  | —         | mV/°C   | $V_{CE} = V_{GE}, I_C = 250 \mu A$              |
| $g_{fe}$                        | Forward Transconductance ④               | 7.5  | —    | —         | S       | $V_{CE} = 100V, I_C = 25A$                      |
| $I_{CES}$                       | Zero Gate Voltage Collector Current      | —    | —    | 100       | $\mu A$ | $V_{GE} = 0V, V_{CE} = 960V$                    |
|                                 |  | —    | —    | 1200      |         | $V_{GE} = 0V, V_{CE} = 960V, T_J = 125^\circ C$ |
| $I_{GES}$                       | Gate-to-Emitter Leakage Current          | —    | —    | $\pm 100$ | nA      | $V_{GE} = \pm 20V$                              |

**Switching Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

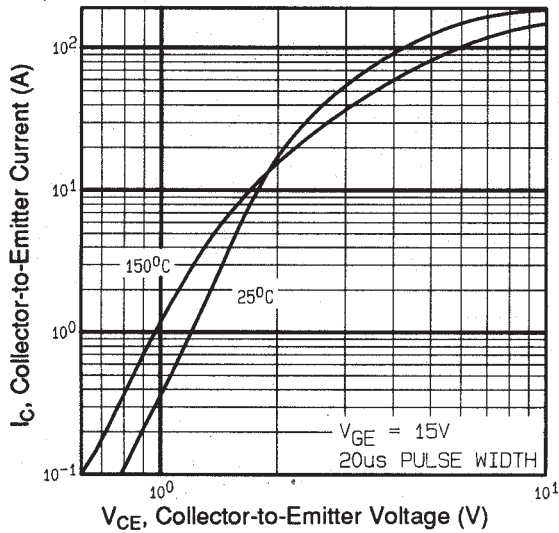
|              | Parameter                         | Min. | Typ. | Max. | Units | Conditions   |
|--------------|-----------------------------------|------|------|------|-------|--|
| $Q_g$        | Total Gate Charge (turn-on)       | —    | —    | 100  | nC    | $I_C = 25A$  |
| $Q_{ge}$     | Gate - Emitter Charge (turn-on)   | —    | —    | 21   |       | $V_{CC} = 400V$ See Fig. 8 ⑤   |
| $Q_{gc}$     | Gate - Collector Charge (turn-on) | —    | —    | 43   |       | $V_{GE} = 15V$   |
| $t_{d(on)}$  | Turn-On Delay Time                | —    | —    | 68   | ns    | $I_C = 25A, V_{CC} = 400V$   |
| $t_r$        | Rise Time                         | —    | —    | 26   |       | $V_{GE} = 15V, R_G = 2.35\Omega$ ⑤   |
| $t_{d(off)}$ | Turn-Off Delay Time               | —    | —    | 480  |       | Energy losses include "tail"   |
| $t_f$        | Fall Time                         | —    | —    | 330  |       | See Fig. 9, 10, 14   |
| $E_{on}$     | Turn-On Switching Loss            | —    | 1.4  | —    |       | mJ   |
| $E_{off}$    | Turn-off Switching Loss           | —    | 4.5  | —    |       |  |
| $E_{ts}$     | Total Switching Loss              | —    | 5.9  | 8.2  |       |  |
| $t_{d(on)}$  | Turn-On Delay Time                | —    | 33   | —    | ns    | $T_J = 125^\circ C$  |
| $t_r$        | Rise Time                         | —    | 15   | —    |       | $I_C = 25A, V_{CC} = 400V$   |
| $t_{d(off)}$ | Turn-Off Delay Time               | —    | 590  | —    |       | $V_{GE} = 15V, R_G = 2.35\Omega$ ⑤   |
| $t_f$        | Fall Time                         | —    | 500  | —    |       | Energy losses include "tail"   |
| $E_{ts}$     | Total Switching Loss              | —    | 13   | —    |       | mJ See Fig. 11, 14   |
| $L_C+L_E$    | Total Inductance                  | —    | 6.8  | —    | nH    | Measured from Collector lead (6mm/0.25in. from package) to Emitter lead (6mm / 0.25in. from package) |
| $C_{ies}$    | Input Capacitance                 | —    | 2400 | —    | pF    | $V_{GE} = 0V$  |
| $C_{oes}$    | Output Capacitance                | —    | 140  | —    |       | $V_{CC} = 30V$ See Fig. 7  |
| $C_{res}$    | Reverse Transfer Capacitance      | —    | 28   | —    |       | $f = 1.0MHz$   |

**Note: Corresponding Spice and Saber models are available on the Website.**

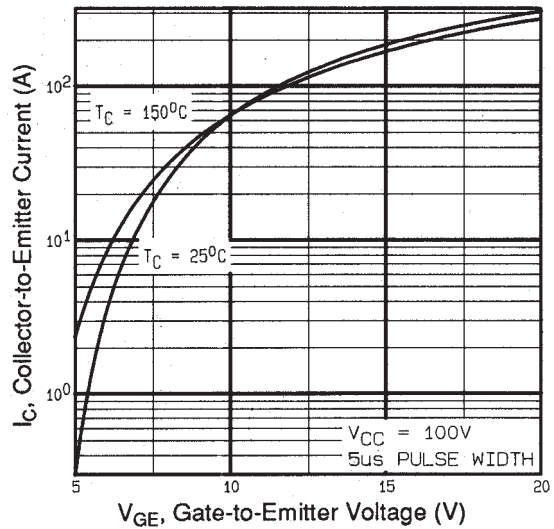
For footnotes refer to the last page



**Fig. 1 - Typical Load Current vs. Frequency**  
(For square wave,  $I = I_{RMS}$  of fundamental; for triangular wave,  $I = I_{PK}$ )



**Fig. 2 - Typical Output Characteristics**



**Fig. 3 - Typical Transfer Characteristics**

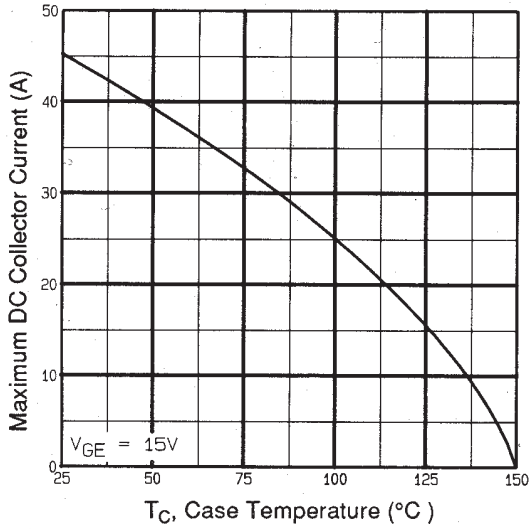


Fig. 4 - Maximum Collector Current vs. Case Temperature

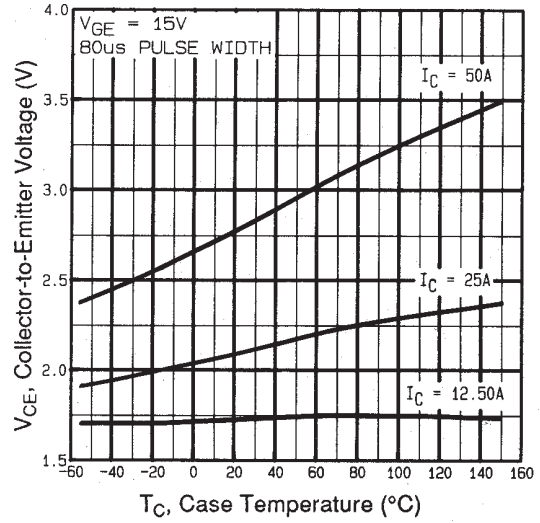


Fig. 5 - Collector-to-Emitter Voltage vs. Junction Temperature

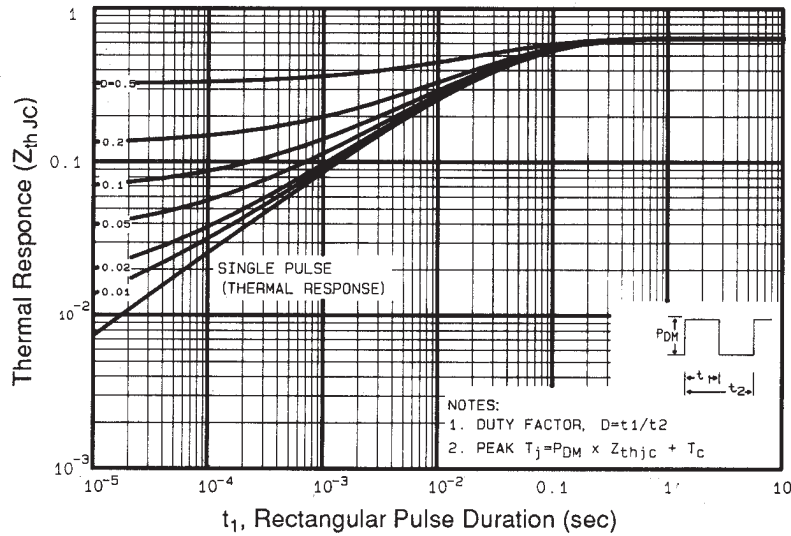


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

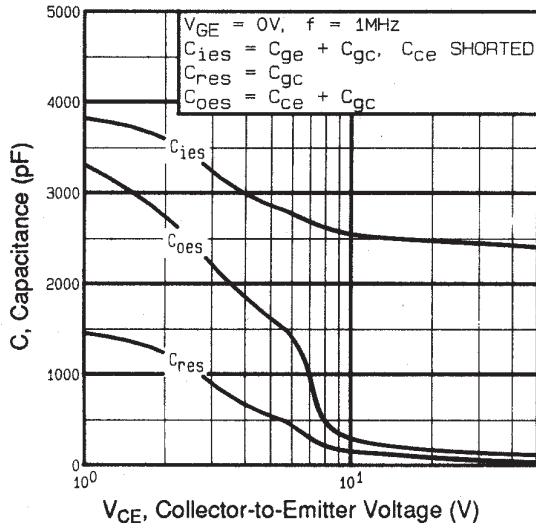


Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage

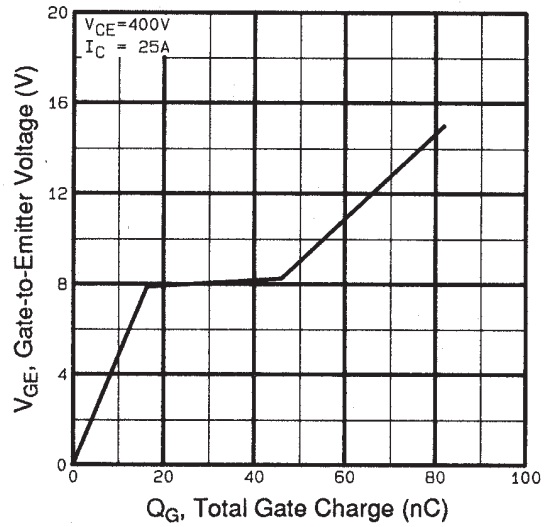


Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage

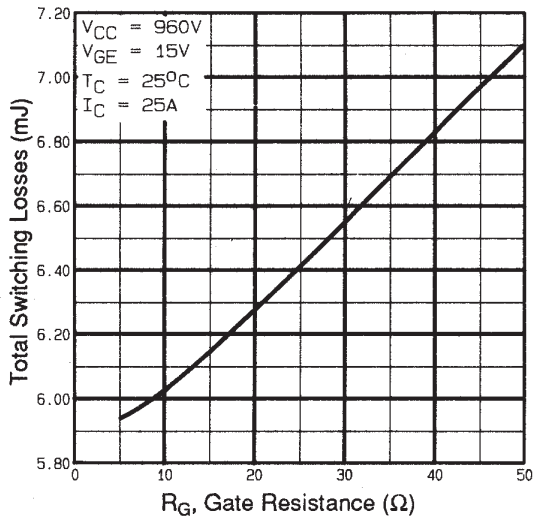


Fig. 9 - Typical Switching Losses vs. Gate Resistance

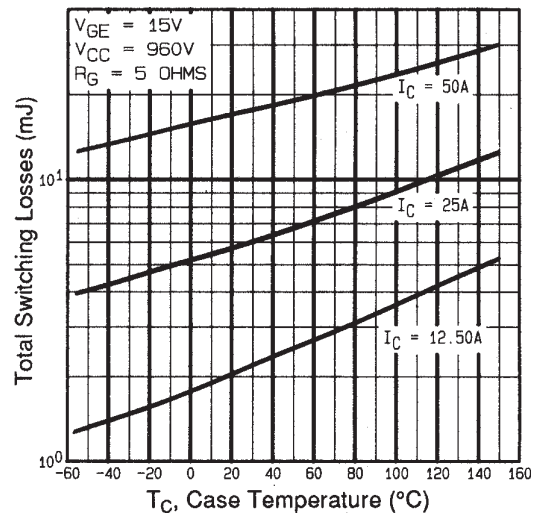
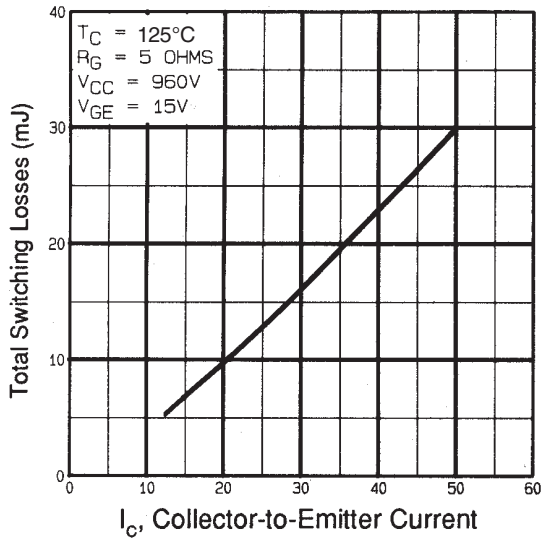
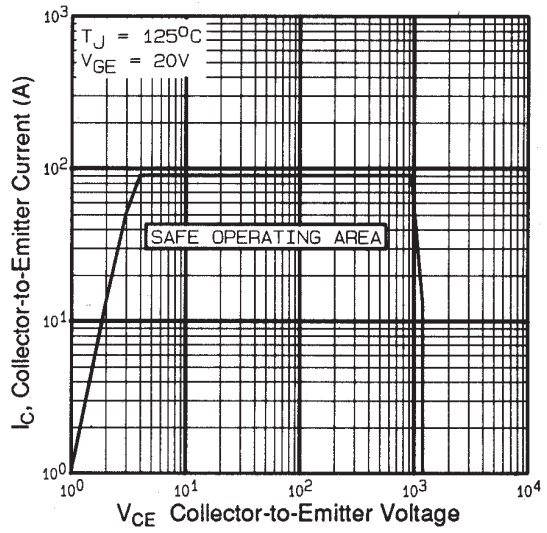


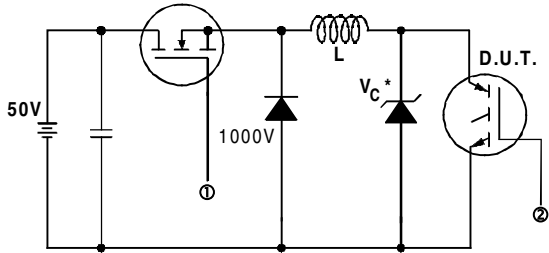
Fig. 10 - Typical Switching Losses vs. Junction Temperature



**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current

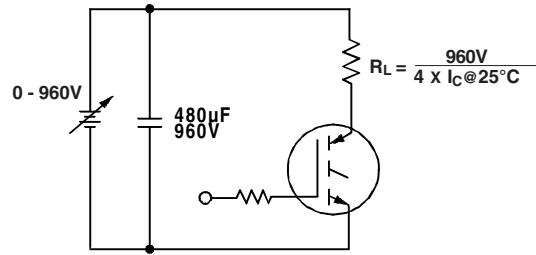


**Fig. 12** - Turn-Off SOA

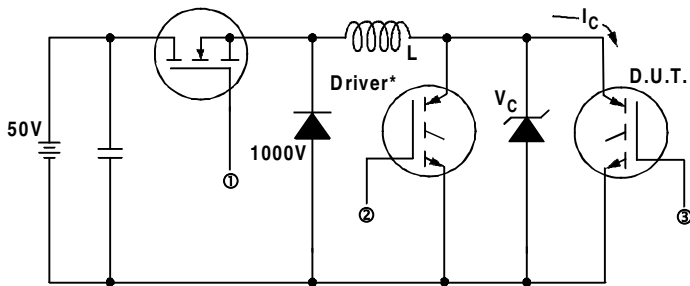


\* Driver same type as D.U.T.;  $V_c = 80\%$  of  $V_{ce(max)}$   
 \* Note: Due to the 50V power supply, pulse width and inductor will increase to obtain rated  $I_d$ .

**Fig. 13a** - Clamped Inductive Load Test Circuit



**Fig. 13b** - Pulsed Collector Current Test Circuit



**Fig. 14a** - Switching Loss Test Circuit

\* Driver same type as D.U.T.,  $V_C = 960V$



**Fig. 14b** - Switching Loss Waveforms

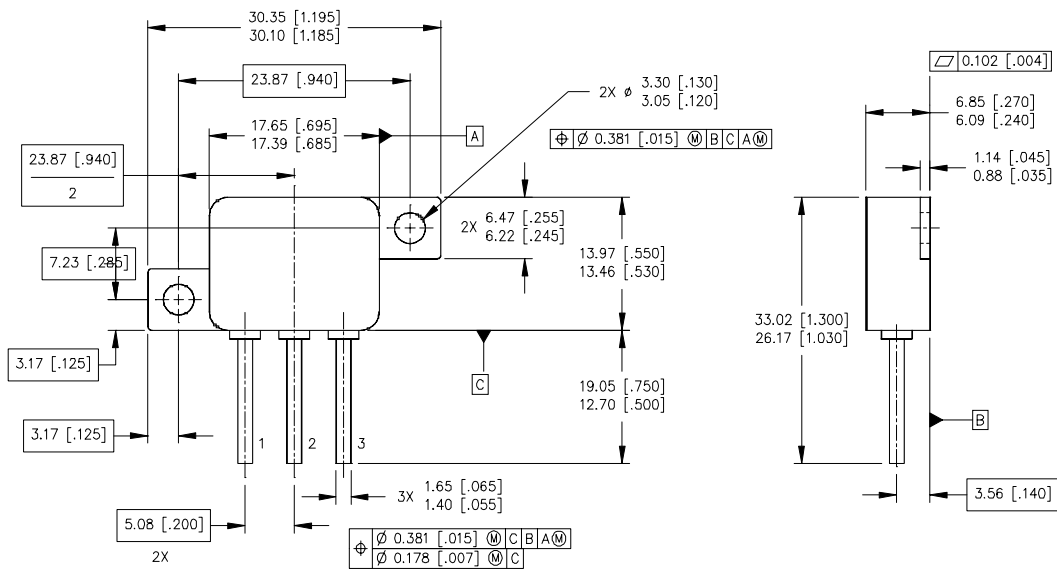
# IRGIH50F

International  
**IR** Rectifier

**Notes:**

- ① Repetitive rating;  $V_{GE} = 20V$ , pulse width limited by max. junction temperature.
- ②  $V_{CC} = 80\%(V_{CES})$ ,  $V_{GE} = 20V$ ,  $L = 10\mu H$ ,  $R_G = 5.0\Omega$
- ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ④ Pulse width  $5.0\mu s$ , single shot.
- ⑤ Equipment limitation.

## Case Outline and Dimensions — TO-259AA



**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME 14.5M-1994.
2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
3. CONTROLLING DIMENSION: INCH
4. CONFORMS TO JEDEC OUTLINE TO-259AA.

**LEGEND**

- 1 = COLLECTOR
- 2 = EMITTER
- 3 = GATE

International  
**IR** Rectifier

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TAC Fax: (310) 252-7903

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